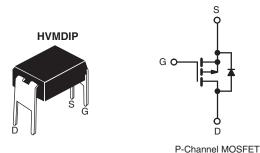


### **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	- 200			
$R_{DS(on)}\left(\Omega\right)$	V <sub>GS</sub> = - 10 V 3.0			
Q <sub>g</sub> (Max.) (nC)	8.9			
Q <sub>gs</sub> (nC)	2.1			
Q <sub>gd</sub> (nC)	3.9			
Configuration	Single			



### **FEATURES**

- · Dynamic dV/dt Rating
- · Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- P-Channel
- · Fast Switching
- · Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

The Power MOSFETs technology is the key to Vishay advanced line of Power MOSFET transistors. The efficient geometry and unique processing of the Power MOSFETs design archieve very low on-state resistance combined with high transconductance and extreme device ruggedness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION			
Package	HVMDIP		
Lead (Pb)-free	IRFD9210PbF		
	SiHFD9210-E3		
SnPb	IRFD9210		
	SiHFD9210		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	- 200	V	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at - 10 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 100 °C	I <sub>D</sub>	- 0.40	A	
Continuous Diairi Current		T <sub>A</sub> = 100 °C		- 0.25		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 3.2		
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	210	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	- 0.40	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	0.10	mJ	
Maximum Power Dissipation	ower Dissipation T <sub>A</sub> = 25 °C		$P_{D}$	1.0	W	
Peak Diode Recovery dV/dtc			dV/dt	- 5.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	- °C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>		

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 123 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 1.6 A (see fig. 12). c.  $I_{SD}$  ≤ 2.3 A, dI/dt ≤ 70 A/ $\mu$ s,  $V_{DD}$  ≤  $V_{DS}$ ,  $T_J$  ≤ 150 °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFD9210, SiHFD9210

# Vishay Siliconix



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		- 200	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = - 1 mA	-	- 0.23	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> =	$V_{GS}$ , $I_D = -250 \mu A$	- 2.0	-	- 4.0	V
Gate-Source Leakage	$I_{GSS}$		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		- 200 V, V <sub>GS</sub> = 0 V V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	- 100 - 500	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}$		_	_	3.0	Ω
Forward Transconductance	9fs	V <sub>DS</sub> = -50 V, I <sub>D</sub> = -0.24 A		0.27	_	-	S
Dynamic	<u>-</u>						
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	170	-	
Output Capacitance	C <sub>oss</sub>	1	V <sub>DS</sub> = - 25 V,		54	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	16	-	'
Total Gate Charge	Qg			-	-	8.9	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = -1.3 A, V <sub>DS</sub> = -160 V see fig. 6 and 13 <sup>b</sup>	-	-	2.1	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	-	3.9	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = -100 \text{ V}, I_{D} = -2.3 \text{ A}$ $R_{g} = 24 \Omega, R_{D} = 41 \Omega,$		-	8.0	-	- ns
Rise Time	t <sub>r</sub>			-	12	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	11	-	
Fall Time	t <sub>f</sub>	]	see fig. 10 <sup>b</sup>		13	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 0.40	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 3.2	
Body Diode Voltage	$V_{SD}$	$T_{J} = 25  ^{\circ}\text{C},  I_{S} = -0.40  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	-	- 5.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = - 2.3 A, dl/dt = 100 A/μs <sup>b</sup> -		-	110	220	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.56	1.1	μC

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width  $\leq$  300  $\mu s$ ; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

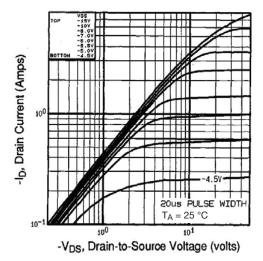


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 25 °C

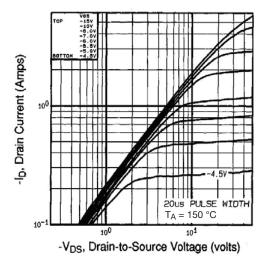


Fig. 2 - Typical Output Characteristics,  $T_A$  = 150 °C

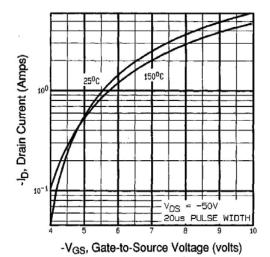


Fig. 3 - Typical Transfer Characteristics

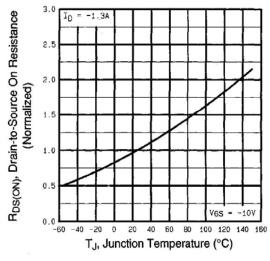


Fig. 4 - Normalized On-Resistance vs. Temperature



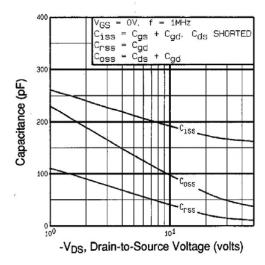


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

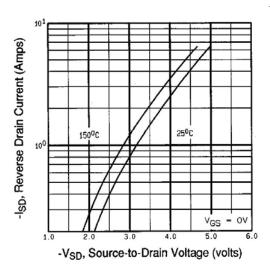


Fig. 7 - Typical Source-Drain Diode Forward Voltage

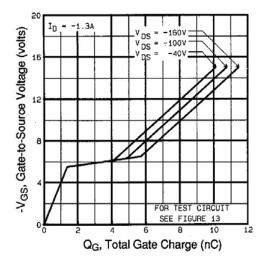


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

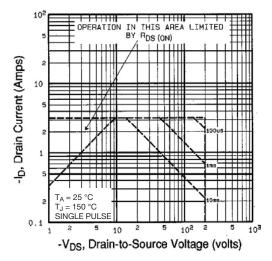


Fig. 8 - Maximum Safe Operating Area



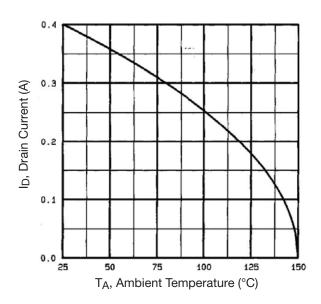


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

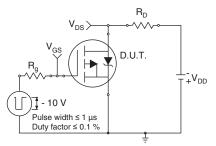


Fig. 10a - Switching Time Test Circuit

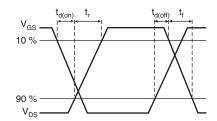


Fig. 10b - Switching Time Waveforms

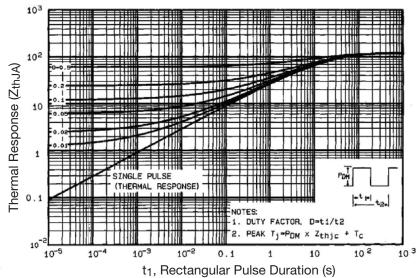


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

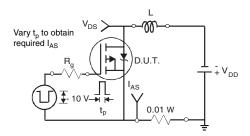


Fig. 12a - Unclamped Inductive Test Circuit

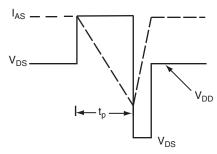


Fig. 12b - Unclamped Inductive Waveforms



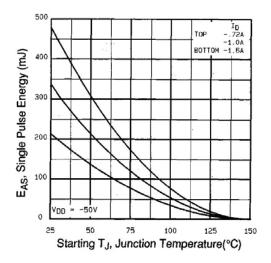


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

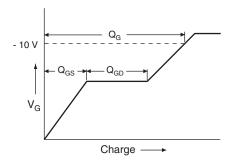


Fig. 13a - Basic Gate Charge Waveform

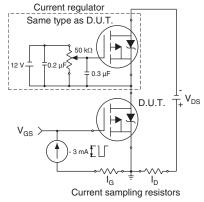
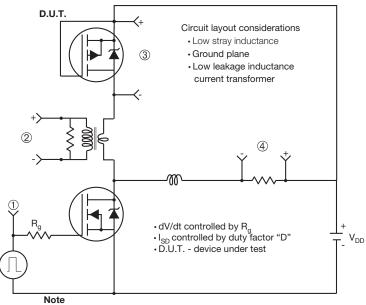


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



· Compliment N-Channel of D.U.T. for driver

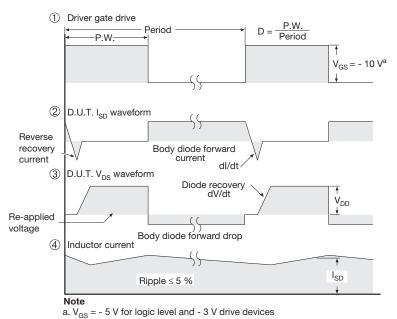
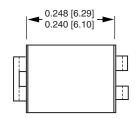
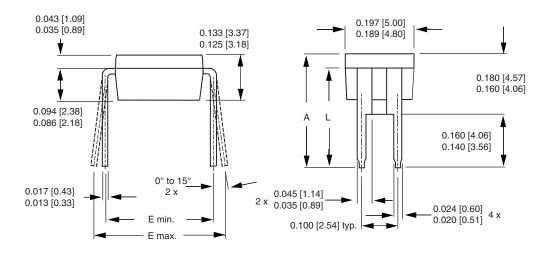


Fig. 14 - For P-Channel

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### **HVM DIP** (High voltage)





	INCHES		MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	0.310	0.330	7.87	8.38	
E	0.300	0.425	7.62	10.79	
L	0.270	0.290	6.86	7.36	

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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